

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.			
Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	400	V
Average Rectified Output Current	lo	5	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	150	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 6)	R _{θJC}	2.0	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	$R_{ ext{ heta}JA}$	16	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	R _θ JC	9.0	°C/W
Typical Thermal Resistance Junction to Ambient (Note 5)	R _θ JA	65	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

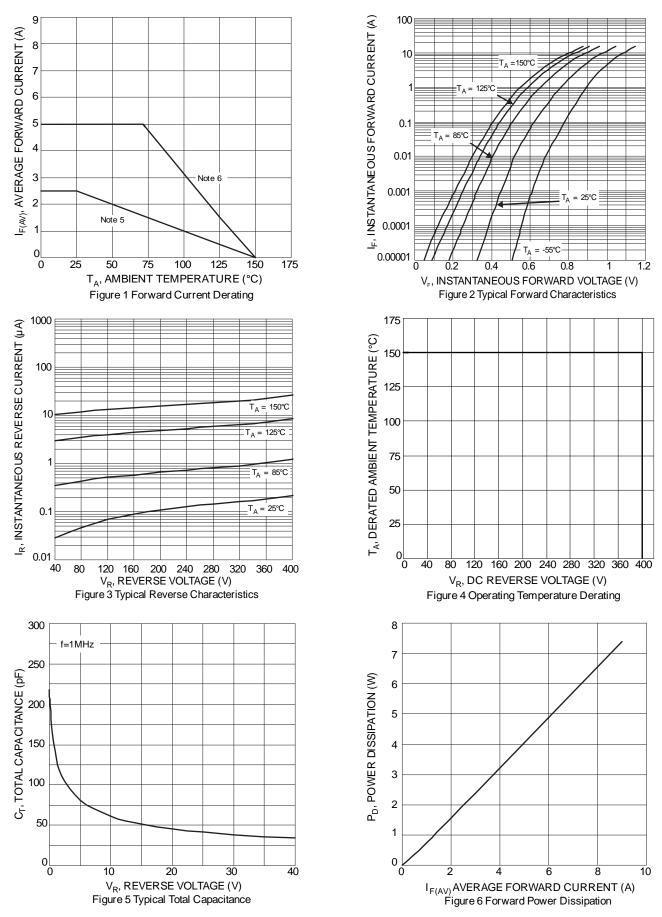
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	400	_	_	V	$I_R = 10 \mu A$
Forward Voltage	VF		0.93 0.74	1.4 1.0	V	I _F = 5A, T _J = +25°C I _F = 5A, T _J = +125°C
Reverse Leakage Current (Note 7)	I _R		0.23 0.008	10 0.2	μA mA	V _R = 400V, T _J = +25°C V _R = 400V, T _J = +125°C
Reverse Recovery Time	t _{rr}	_	35	45	ns	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$
Junction Capacitance	CJ	_	61	_	pf	$V_R = 10V_{DC}$, f = 1MHz

 Device mounted on FR4 PCB, 2oz with 1x recommended pad layout.
Device mounted on 2-inch Al substrate. Notes:

7. Short duration pulse test used to minimize self-heating effect.



UF5GD1

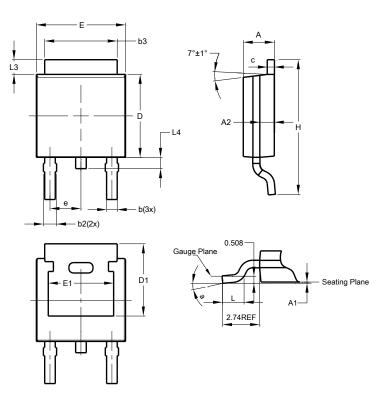


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Package Outline Dimensions

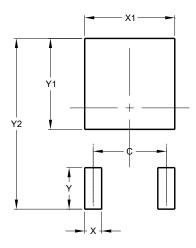
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	TO252 (DPAK)					
Dim	Min	Max	Тур			
Α	2.19	2.39	2.29			
A1	0.00	0.13	0.08			
A2	0.97	1.17	1.07			
b	0.64	0.88	0.783			
b2	0.76	1.14	0.95			
b3	5.21	5.46	5.33			
С	0.45	0.58	0.531			
D	6.00	6.20	6.10			
D1	5.21	-	-			
е	-	-	2.286			
Е	6.45	6.70	6.58			
E1	4.32	-	-			
н	9.40	10.41	9.91			
L	1.40	1.78	1.59			
L3	0.88	1.27	1.08			
L4	0.64	1.02	0.83			
а	0°	10°	-			
All	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	4.572
Х	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700



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